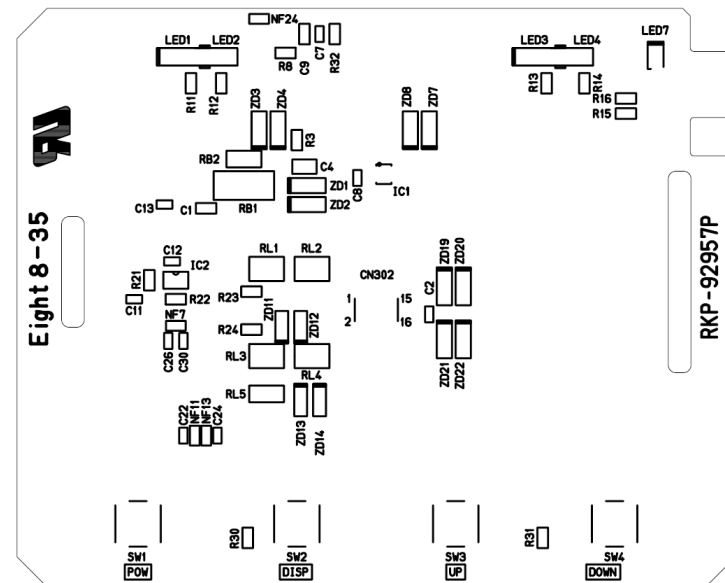
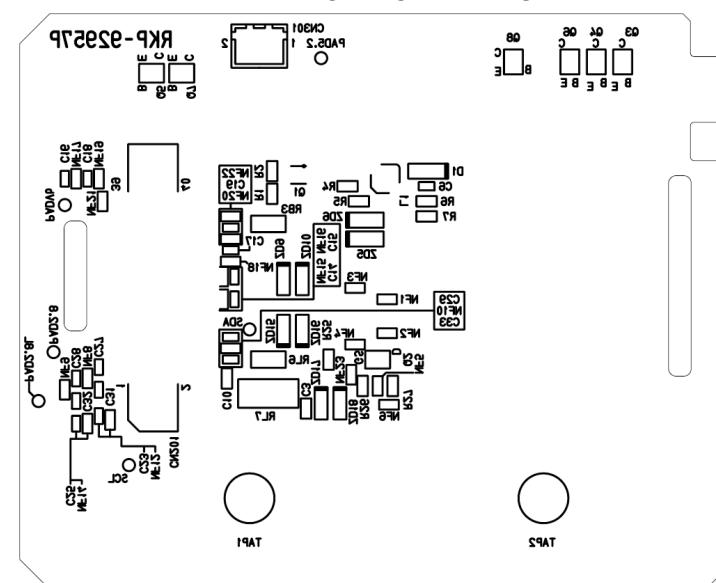


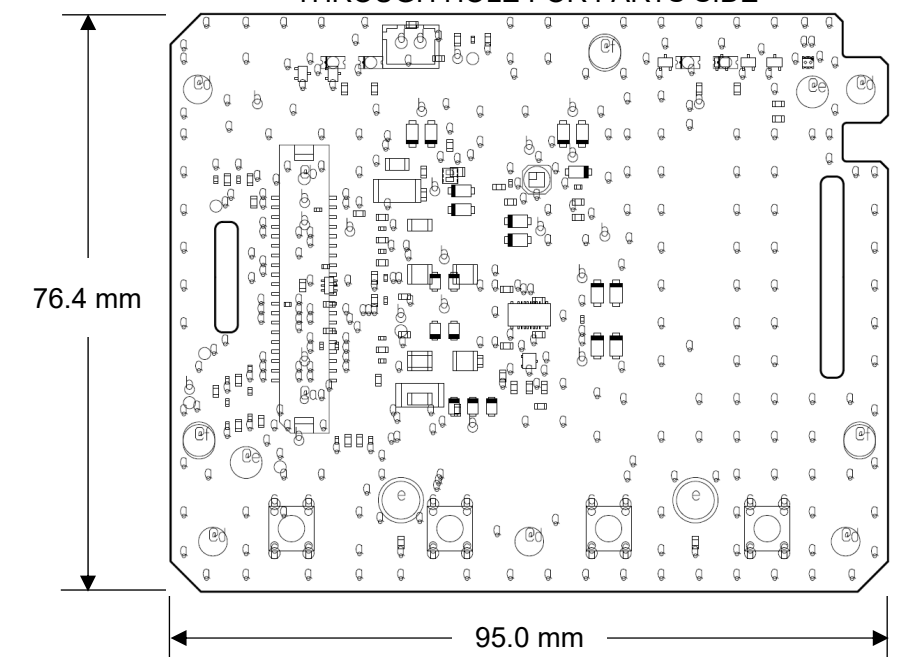
SILK PRINT FOR PARTS SIDE



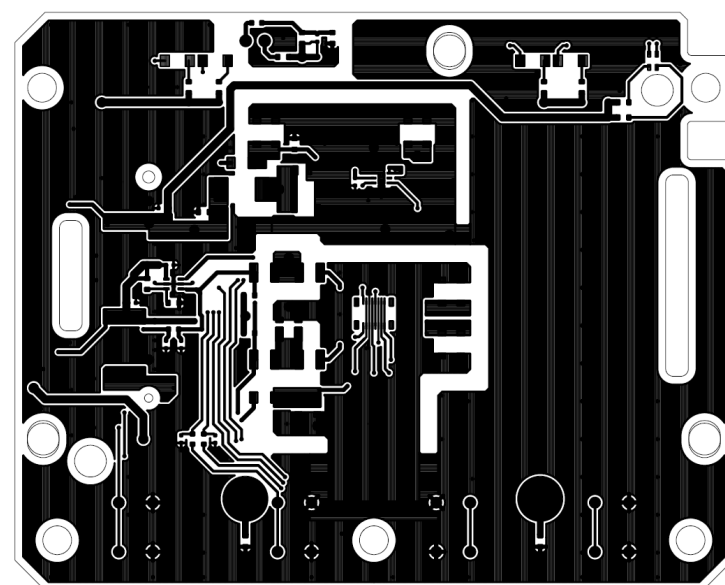
SILK PRINT FOR SOLDERING SIDE



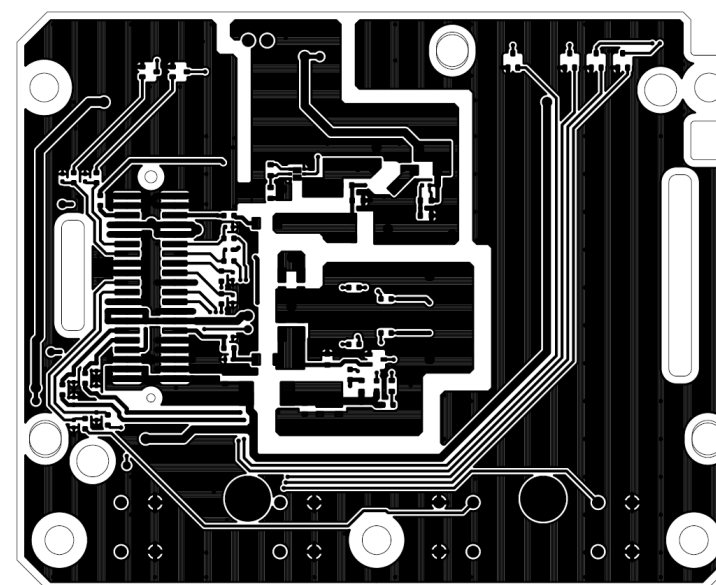
THROUGH HOLE FOR PARTS SIDE



PARTS SIDE



SOLDERING SIDE



MARK	DIAGRAM	HOLE	MEMO
a	$\phi 0.3$	TH	
b	$\phi 0.7$	TH	
c	$\phi 1$	TH	
d	$\phi 1.1$	TH	
e	$\phi 3.7$	TH	
@a	$\phi 1.1$	NTH	
@b	$\phi 1.6$	NTH	
@d	$\phi 3.8$	NTH	
@e	$\phi 4.2$	NTH	
@f	$\phi 4.2 \times 4.9$	NTH	

SPECIFICATION FOR PCB

- PCB No. : RKP-92957P
- Material : Glass epoxy
- Thickness : 1.6mm
- Layer number : 2
- Thickness copper film : 35um
- Copper thickness of the via's : 35um above.
- Minimum conductor width : 0.23mm
- CTI : 100 above

All drawings are view of parts side

SCALE 1:1

注 記 NOTES		改版担当者 REV. BY	改版日 REVISED	名 称 NAME LCD PCB EAGLE3
改版回数 REV. 0	総頁数 PAGES 1			
承認 APPROVED 山田和則	検討 CHECKED 小野圭	製 図 DRAWN 木村司	作成日 DATE 2024.2.21	図 番 DWG. NO. E 3 - 6 9 9 1 - 6 5 1 5 - 0 0 - 0 1 A
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